# OSRAM LUW HWQP Datasheet

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved

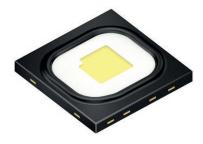




## **OSLON® Black Flat**

## LUW HWQP speci fied at 350 mA

OSLON Black Flat is a new small size high-flux LED for slim designs. The black package stands for high stability.





#### **Applications**

- Static Forward Lighting

#### **Features**

- Package: SMD epoxy package
- Chip technology: UX:3
- Typ. Radiation: 120° (Lambertian emitter)
- Color: Cx = 0.33, Cy = 0.34 acc. to CIE 1931 (• ultra white)
- Corrosion Robustness Class: 3B
- Qualifications: AEC-Q102 Qualified with RV-level 1
- ESD: 8 kV acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)



## Ordering Information

Туре	Luminous Flux <sup>1)</sup> I <sub>F</sub> = 350 mA $\Phi_V$	Ordering Code	
LUW HWQP-5L8L-ebvF46fcbB46-8E8G	112 180 lm	Q65111A7571	



## **Maximum Ratings**

Parameter	Symbol		Values
Operating Temperature	T <sub>op</sub>	min.	-40 °C
	op	max.	125 °C
Storage Temperature	T <sub>stg</sub>	min.	-40 °C
	3	max.	125 °C
Junction Temperature	T <sub>j</sub>	max.	150 °C
Junction Temperature for short time applications*	T <sub>j</sub>	max.	175 °C
Forward current	I <sub>F</sub>	min.	50 mA
T <sub>s</sub> = 25 °C		max.	1500 mA
Surge current $t < 10 \text{ uc}; D = 0.005 \text{ ; } T = 25 \text{ °C}$	I <sub>FS</sub>	max.	2500 mA
t ≤ 10 μs; D = 0.005 ; T <sub>s</sub> = 25 °C			
ESD withstand voltage acc. to ANSI/ESDA/JEDEC JS-001 (HBM, Class 3B)	$V_{ESD}$		8 kV
Reverse current <sup>2)</sup>	I <sub>R</sub>	max.	200 mA

\* The median lifetime (L70/B50) for Tj =  $175^{\circ}$ C is 100h.



#### Characteristics

I<sub>F</sub> = 350 mA; T<sub>S</sub> = 25 °C

Parameter	Symbol		Values
Chromaticity Coordinate <sup>3)</sup>	Cx	typ.	0.33
	Су	typ.	0.34
Viewing angle at 50% $I_v$	2φ	typ.	120 °
Forward Voltage 4)	V <sub>F</sub>	min.	2.75 V
I <sub>F</sub> = 350 mA		typ.	2.85 V
		max.	3.50 V
Reverse voltage (ESD device)	V <sub>r esd</sub>	min.	45 V
Reverse voltage <sup>2)</sup> I <sub>R</sub> = 20 mA	V <sub>R</sub>	max.	1.2 V
Real thermal resistance junction/solderpoint <sup>5)</sup>	$R_{thJS real}$	typ.	4.3 K / W
	this real	max.	5.5 K / W
Electrical thermal resistance junction/solderpoint <sup>5)</sup>	$R_{thJSelec.}$	typ.	3.0 K / W
with efficiency $\eta_{\rm e}$ = 30 %		max.	3.9 K / W



## **Brightness Groups**

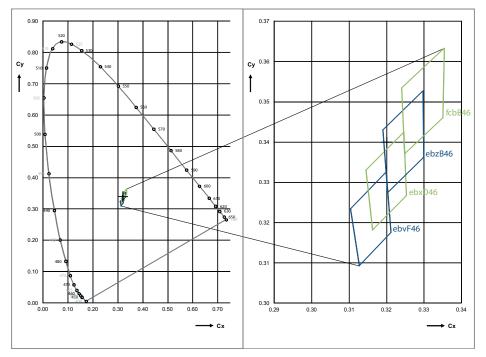
Group	Luminous Flux <sup>1)</sup> I <sub>F</sub> = 350 mA min. Φ <sub>v</sub>	Luminous Flux <sup>1)</sup> I <sub>F</sub> = 350 mA max. Φ <sub>V</sub>	Luminous Intensity <sup>6)</sup> I <sub>F</sub> = 350 mA typ. I <sub>v</sub>
5L	112 lm	125 lm	39 cd
6L	125 lm	140 lm	44 cd
7L	140 lm	159 lm	49 cd
8L	159 lm	180 lm	56 cd

#### Forward Voltage Groups

Group	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 350 mA min. V <sub>F</sub>	Forward Voltage <sup>4)</sup> I <sub>F</sub> = 350 mA max. V <sub>F</sub>	
8E	2.75 V	3.00 V	
8F	3.00 V	3.25 V	
8G	3.25 V	3.50 V	



## Chromaticity Coordinate Groups <sup>3)</sup>



## Chromaticity Coordinate Groups <sup>3)</sup>

Group	Сх	Су	Group	Сх	Су
ebvF46	0.3104	0.3234	ebzB46	0.3190	0.3430
	0.3199	0.3325		0.3298	0.3526
	0.3212	0.3175		0.3299	0.3361
	0.3127	0.3093		0.3203	0.3274
ebxD46	0.3145	0.3330	fcbB46	0.3241	0.3534
	0.3246	0.3424		0.3355	0.3633
	0.3253	0.3266		0.3350	0.3460
	0.3163	0.3181		0.3248	0.3370



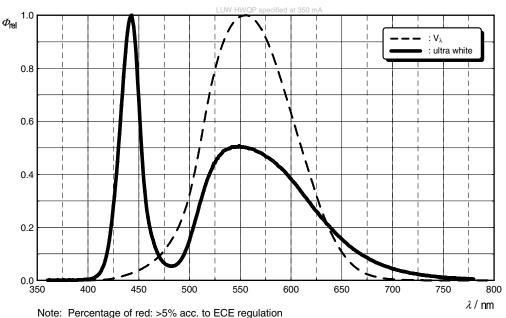
\_

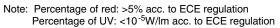
Group Name on La	abel			
Example: 5L-ebvF46-8E				
Brightness	Color Chromaticity	Forward Voltage		
5L	ebvF46	8E		



## **Relative Spectral Emission**<sup>6)</sup>

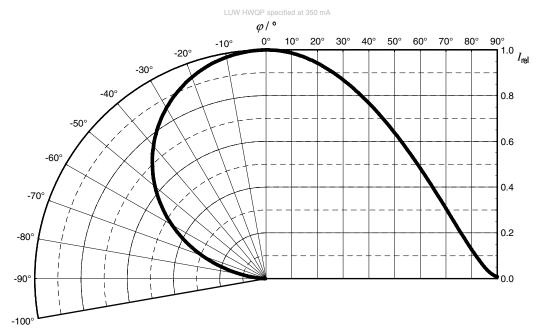
 $\Phi_{rel}$  = f ( $\lambda$ ); I<sub>F</sub> = 350 mA; T<sub>S</sub> = 25 °C





#### Radiation Characteristics <sup>6)</sup>

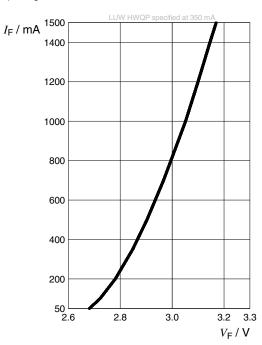
I<sub>rel</sub> = f (φ); T<sub>s</sub> = 25 °C





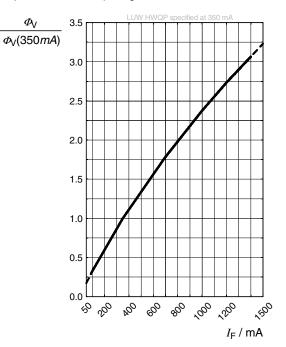
#### Forward current <sup>6)</sup>

 $I_{_{\rm F}} = f(V_{_{\rm F}}); T_{_{\rm S}} = 25 \ ^{\circ}{\rm C}$ 



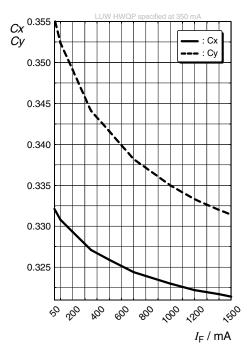
#### Relative Luminous Flux <sup>6), 7)</sup>

 $\Phi_{v}/\Phi_{v}(350 \text{ mA}) = f(I_{F}); T_{S} = 25 \text{ °C}$ 



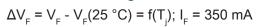
#### Chromaticity Coordinate Shift 6)

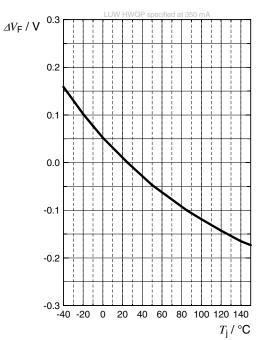
Cx, Cy =  $f(I_F)$ ; T<sub>S</sub> = 25 °C





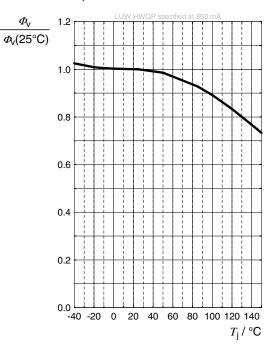
#### Forward Voltage <sup>6)</sup>





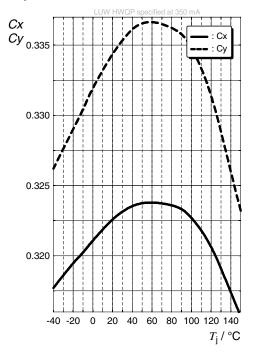
#### **Relative Luminous Flux**<sup>6)</sup>

 $\Phi_{v}/\Phi_{v}(25 \text{ °C}) = f(T_{i}); I_{F} = 350 \text{ mA}$ 



#### Chromaticity Coordinate Shift <sup>6)</sup>

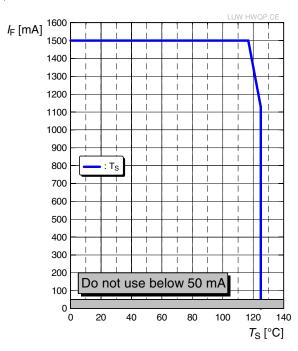
Cx, Cy =  $f(T_i)$ ;  $I_F = 350 \text{ mA}$ 





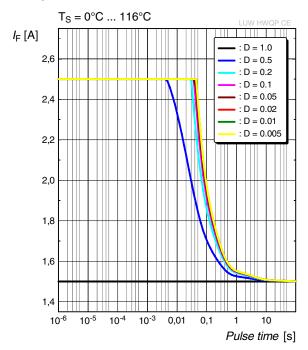
#### Max. Permissible Forward Current <sup>5)</sup>

 $I_{F} = f(T)$ 

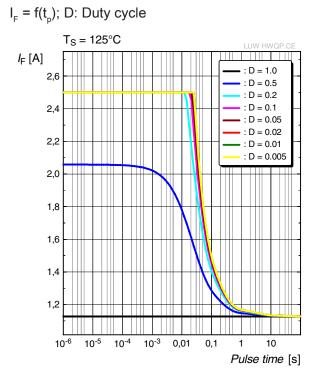


#### Permissible Pulse Handling Capability

 $I_{F} = f(t_{p}); D: Duty cycle$ 

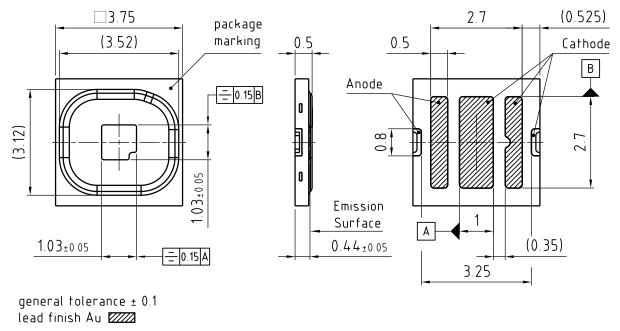


#### Permissible Pulse Handling Capability





#### **Dimensional Drawing**<sup>8)</sup>



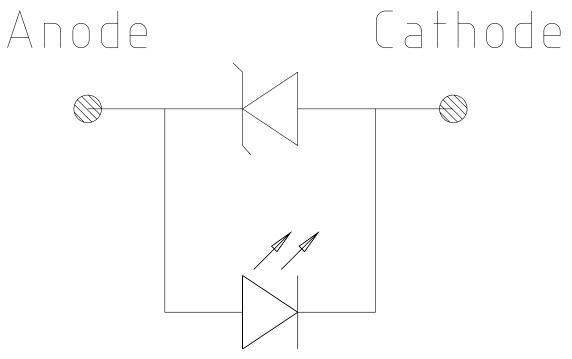
C67062-A0081-A1-05

#### **Further Information:**

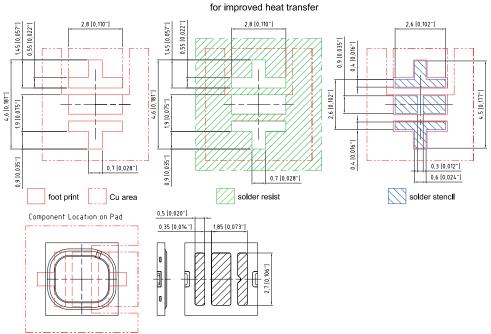
Approximate Weight:	23.0 mg
Corrosion test:	Class: 3B Test condition: 40°C / 90 % RH / 15 ppm H <sub>2</sub> S / 14 days (stricter than IEC 60068-2-43)
ESD advice:	The device is protected by ESD device which is connected in parallel to the Chip.



#### **Electrical Internal Circuit**



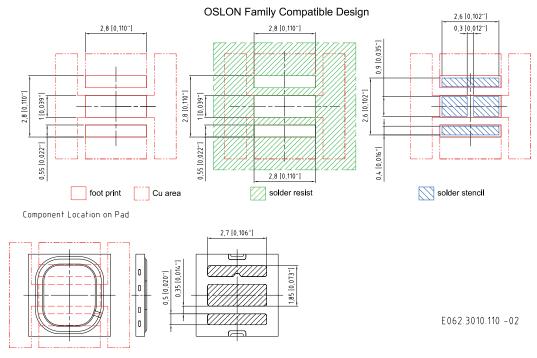
#### Recommended Solder Pad<sup>8)</sup>



E062.3010.107 -02



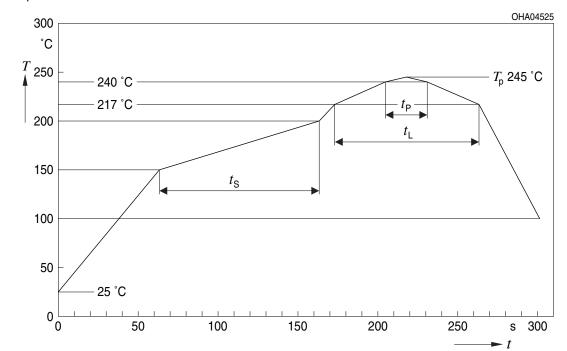
#### Recommended Solder Pad<sup>8)</sup>



For superior solder joint connectivity results we recommend soldering under standard nitrogen atmosphere. In case the PCB layout of the application is intended to be used with other OSLON derivates or in future developed OSLON derivates, the heat sink must not be electrically connected to anode or cathode solder pad because of possible chip inverted polarity. Package not suitable for ultra sonic cleaning. To ensure a high solder joint reliability and to minimize the risk of solder joint cracks, the customer is responsible to evaluate the combination of PCB board and solder paste material for his application.



#### **Reflow Soldering Profile**



Product complies to MSL Level 2 acc. to JEDEC J-STD-020E

Profile Feature	Symbol	Symbol Pb-Free (SnAgCu) Assembly			Unit	
		Minimum	Recommendation	Maximum		
Ramp-up rate to preheat <sup>*)</sup> 25 °C to 150 °C			2	3	K/s	
Time t <sub>s</sub> T <sub>smin</sub> to T <sub>smax</sub>	t <sub>s</sub>	60	100	120	S	
Ramp-up rate to peak $^{*)}$ T $_{\rm Smax}$ to T $_{\rm P}$			2	3	K/s	
Liquidus temperature	TL		217		°C	
Time above liquidus temperature	t		80	100	S	
Peak temperature	Τ <sub>Ρ</sub>		245	260	°C	
Time within 5 °C of the specified peak temperature $T_p$ - 5 K	t <sub>P</sub>	10	20	30	S	
Ramp-down rate* T <sub>P</sub> to 100 °C			3	6	K/s	
Time 25 °C to T <sub>P</sub>				480	S	

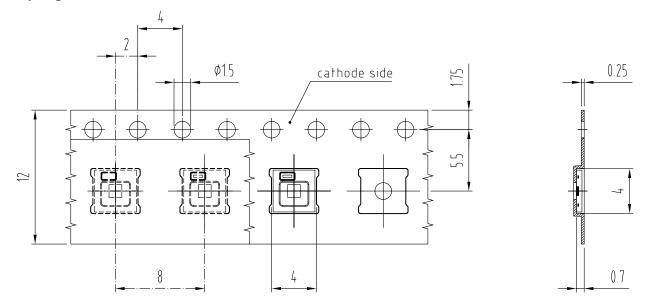
All temperatures refer to the center of the package, measured on the top of the component

\* slope calculation DT/Dt: Dt max. 5 s; fulfillment for the whole T-range

## LUW HWQP specified at 350 mA DATASHEET



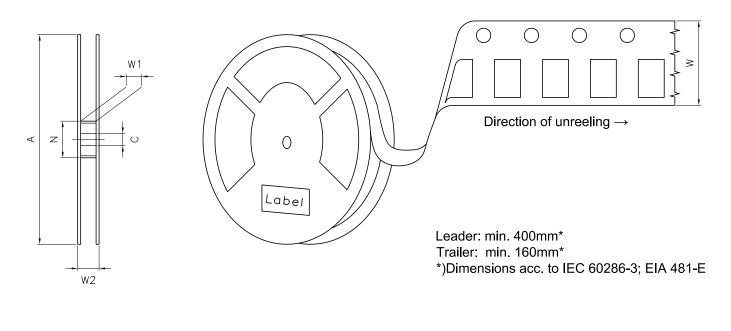
Taping<sup>8)</sup>



C67062-A0345-B11-04



#### Tape and Reel <sup>9)</sup>

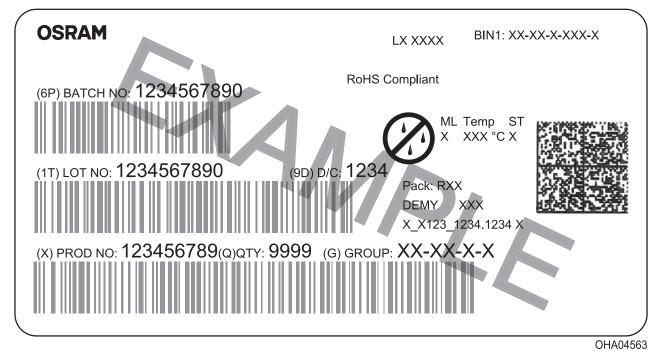


#### **Reel Dimensions**

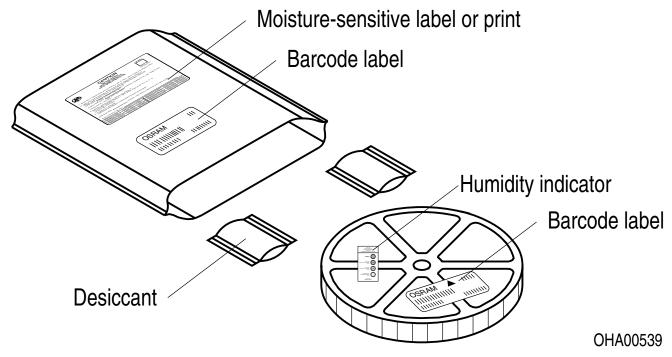
А	W	N <sub>min</sub>	W <sub>1</sub>	$W_{2 \max}$	Pieces per PU
180 mm	12 + 0.3 / - 0.1 mm	60 mm	12.4 + 2 mm	18.4 mm	2000



#### **Barcode-Product-Label (BPL)**



## Dry Packing Process and Materials<sup>8)</sup>



Moisture-sensitive product is packed in a dry bag containing desiccant and a humidity card according JEDEC-STD-033.



#### Notes

The evaluation of eye safety occurs according to the standard IEC 62471:2006 (photo biological safety of lamps and lamp systems). Within the risk grouping system of this IEC standard, the device specified in this data sheet fall into the class **moderate risk (exposure time 0.25 s)**. Under real circumstances (for exposure time, conditions of the eye pupils, observation distance), it is assumed that no endangerment to the eye exists from these devices. As a matter of principle, however, it should be mentioned that intense light sources have a high secondary exposure potential due to their blinding effect. When looking at bright light sources (e.g. headlights), temporary reduction in visual acuity and afterimages can occur, leading to irritation, annoyance, visual impairment, and even accidents, depending on the situation.

Subcomponents of this device contain, in addition to other substances, metal filled materials including silver. Metal filled materials can be affected by environments that contain traces of aggressive substances. Therefore, we recommend that customers minimize device exposure to aggressive substances during storage, production, and use. Devices that showed visible discoloration when tested using the described tests above did show no performance deviations within failure limits during the stated test duration. Respective failure limits are described in the IEC60810.

For further application related information please visit https://ams-osram.com/support/application-notes



#### Disclaimer

#### Attention please!

The information describes the type of component and shall not be considered as assured characteristics. Terms of delivery and rights to change design reserved. Due to technical requirements components may contain dangerous substances.

For information on the types in question please contact our Sales Organization.

If printed or downloaded, please find the latest version on our website.

#### Packing

Please use the recycling operators known to you. We can also help you – get in touch with your nearest sales office. By agreement we will take packing material back, if it is sorted. You must bear the costs of transport. For packing material that is returned to us unsorted or which we are not obliged to accept, we shall have to invoice you for any costs incurred.

#### Product and functional safety devices/applications or medical devices/applications

Our components are not developed, constructed or tested for the application as safety relevant component or for the application in medical devices.

Our products are not qualified at module and system level for such application.

In case buyer – or customer supplied by buyer – considers using our components in product safety devices/ applications or medical devices/applications, buyer and/or customer has to inform our local sales partner immediately and we and buyer and /or customer will analyze and coordinate the customer-specific request between us and buyer and/or customer.

#### Glossary

- <sup>1)</sup> **Brightness:** Brightness values are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 8$  % and an expanded uncertainty of  $\pm 11$  % (acc. to GUM with a coverage factor of k = 3).
- <sup>2)</sup> **Reverse Operation:** This product is intended to be operated applying a forward current within the specified range. Applying any continuous reverse bias or forward bias below the voltage range of light emission shall be avoided because it may cause migration which can change the electro-optical characteristics or damage the LED.
- <sup>3)</sup> Chromaticity coordinate groups: Chromaticity coordinates are measured during a current pulse of typically 25 ms, with an internal reproducibility of  $\pm 0.005$  and an expanded uncertainty of  $\pm 0.01$  (acc. to GUM with a coverage factor of k = 3).
- <sup>4)</sup> **Forward Voltage:** The forward voltage is measured during a current pulse of typically 8 ms, with an internal reproducibility of  $\pm 0.05$  V and an expanded uncertainty of  $\pm 0.1$  V (acc. to GUM with a coverage factor of k = 3).
- <sup>5)</sup> **Thermal Resistance:** Rth max is based on statistic values ( $6\sigma$ ) used for Derating.
- <sup>6)</sup> **Typical Values:** Due to the special conditions of the manufacturing processes of semiconductor devices, the typical data or calculated correlations of technical parameters can only reflect statistical figures. These do not necessarily correspond to the actual parameters of each single product, which could differ from the typical data and calculated correlations or the typical characteristic line. If requested, e.g. because of technical improvements, these typ. data will be changed without any further notice.
- <sup>7)</sup> **Characteristic curve:** In the range where the line of the graph is broken, you must expect higher differences between single devices within one packing unit.
- <sup>8)</sup> **Tolerance of Measure:** Unless otherwise noted in drawing, tolerances are specified with ±0.1 and dimensions are specified in mm.
- <sup>9)</sup> **Tape and Reel:** All dimensions and tolerances are specified acc. IEC 60286-3 and specified in mm.



#### **Revision History**

Version	Date	Change
1.4	2020-09-25	Features
		Further Information
		Recommended Solder Pad
		Reel Dimensions
		Schematic Transportation Box
		Dimensions of Transportation Box
		Type Designation System
		Notes
		Disclaimer
		Glossary
1.5	2023-11-28	Features
		New Layout
		Applications



EU RoHS and China RoHS compliant product 此产品符合欧盟 RoHS 指令的要求; 按照中国的相关法规和标准, 不含有毒有害物质或元素。

Published by ams-OSRAM AG Tobelbader Strasse 30, 8141 Premstaetten, Austria Phone +43 3136 500-0 ams-osram.com © All rights reserved

